

Lecture 17

The Bipolar Junction Transistor (I)

Forward Active Regime

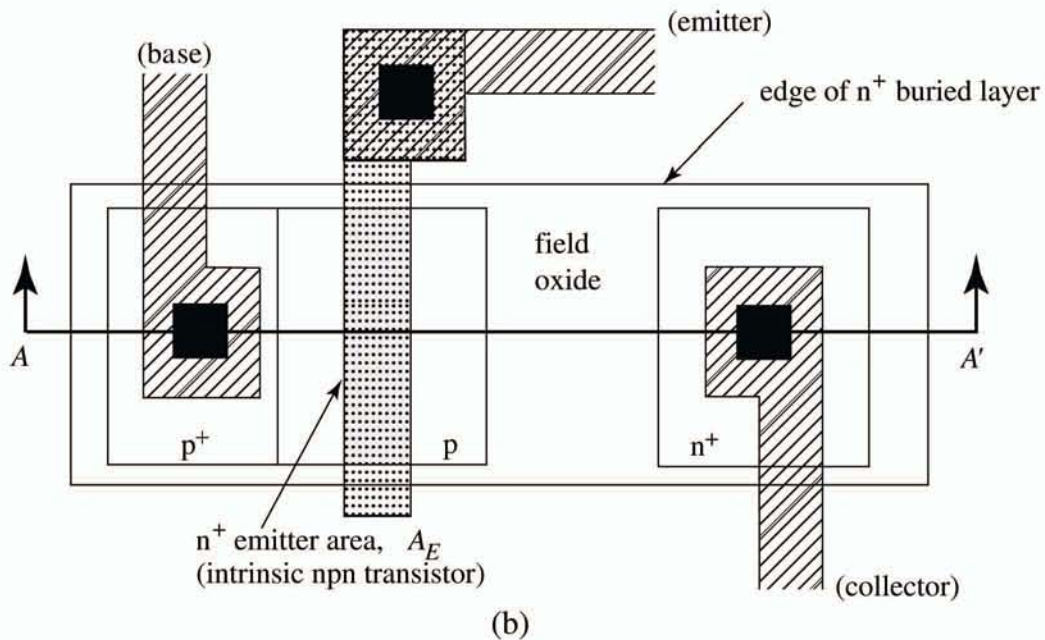
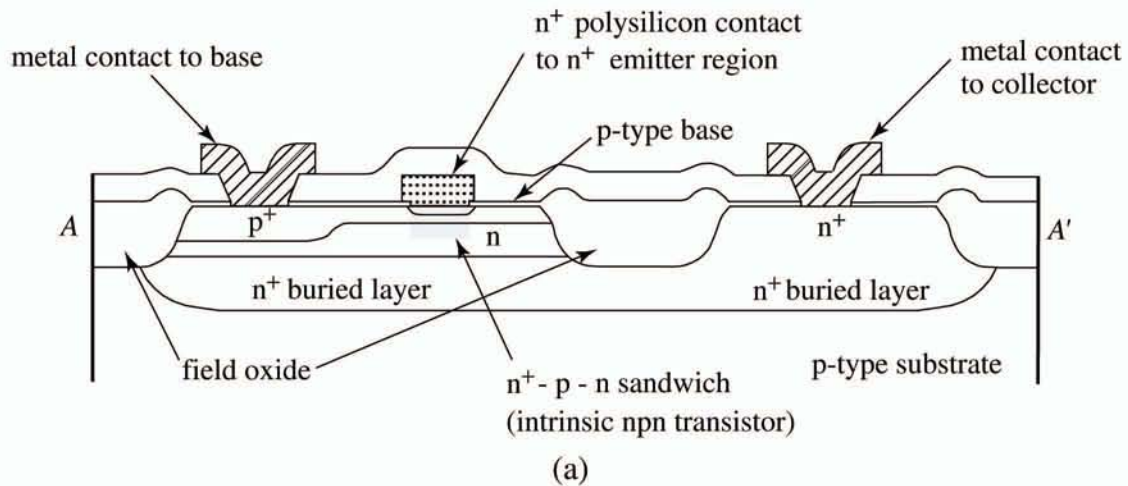
Outline

- The Bipolar Junction Transistor (BJT):
 - structure and basic operation
- I-V characteristics in forward active regime

Reading Assignment:

Howe and Sodini; Chapter 7, Sections 7.1, 7.2

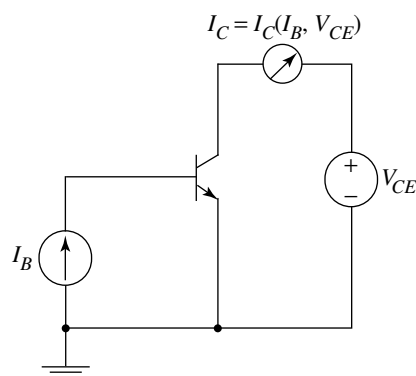
1. BJT: structure and basic operation



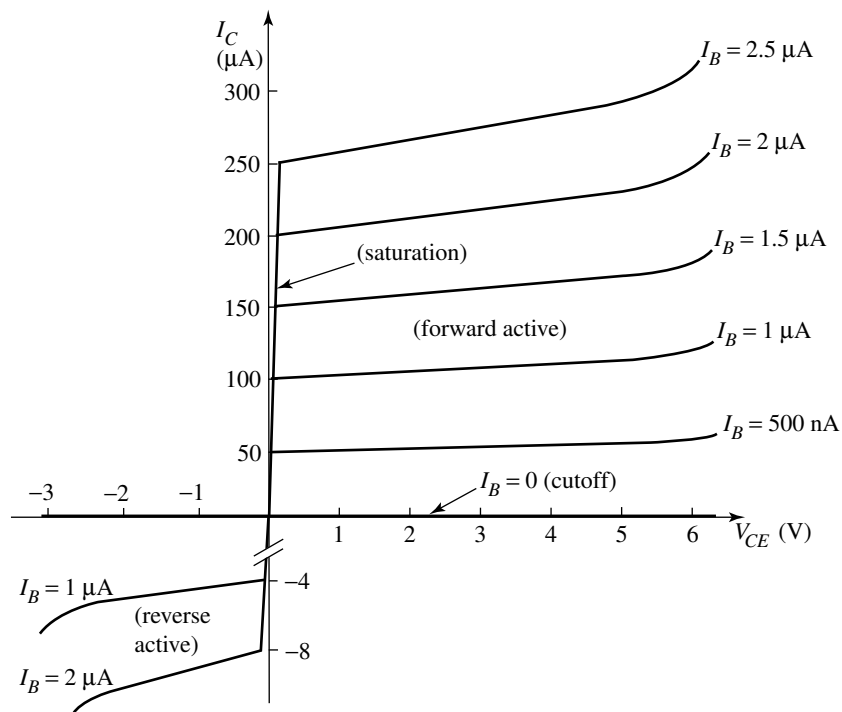
Bipolar Junction Transistor: excellent for analog and front-end communications applications.

NPN BJT Collector Characteristics

Similar to test circuit as for an n-channel MOSFET
...except I_B is the control variable rather than V_{BE}

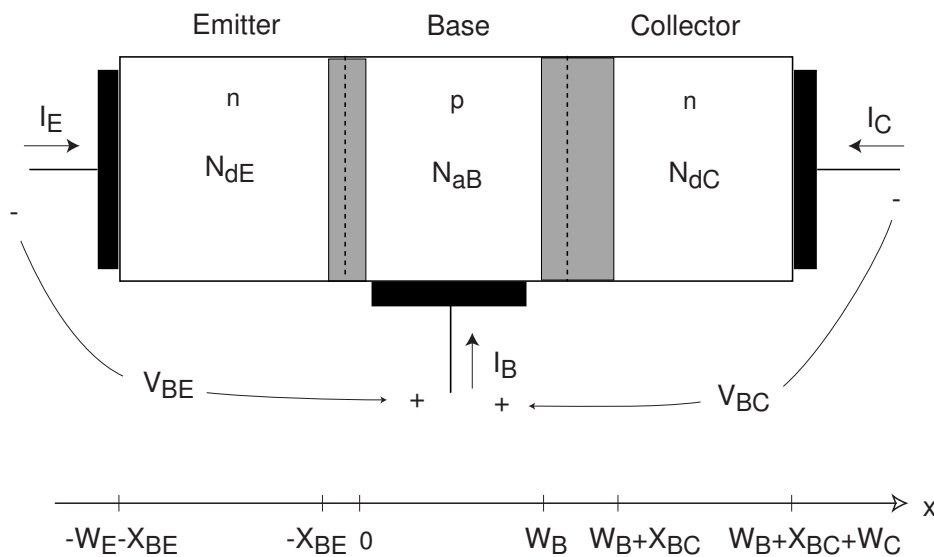


(a)



(b)

Simplified one-dimensional model of intrinsic device:

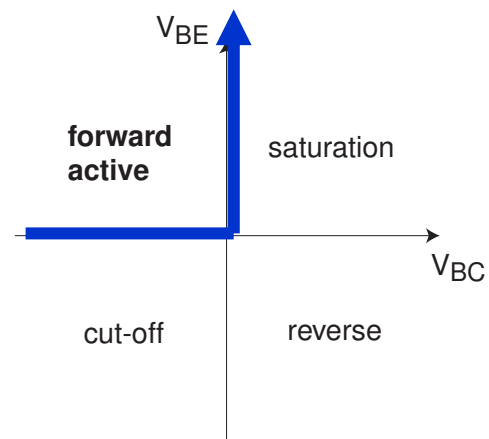
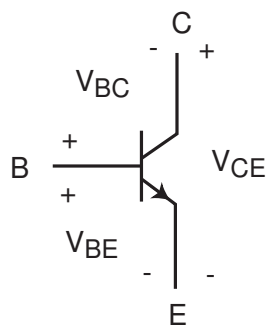


BJT=two neighboring pn junctions back-to-back

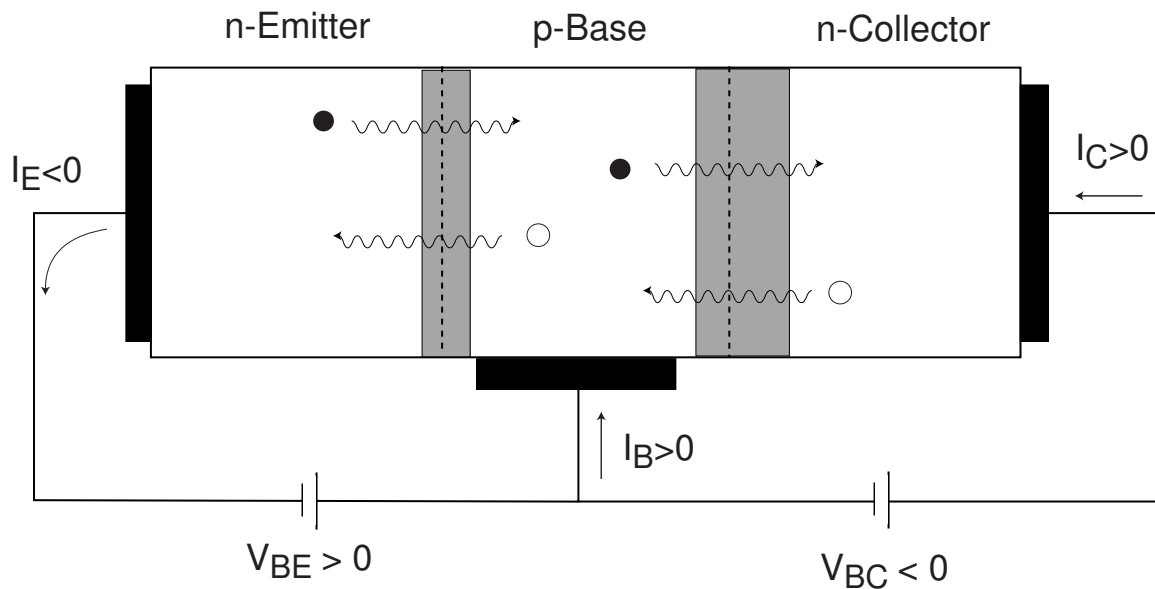
- Close enough for minority carriers to interact
 - \Rightarrow can diffuse quickly through the base
- Far apart enough for depletion regions not to interact
 - \Rightarrow prevent “punchthrough”

Regions of operation:

$$V_{CE} = V_{BE} - V_{BC}$$



Basic Operation: forward-active regime

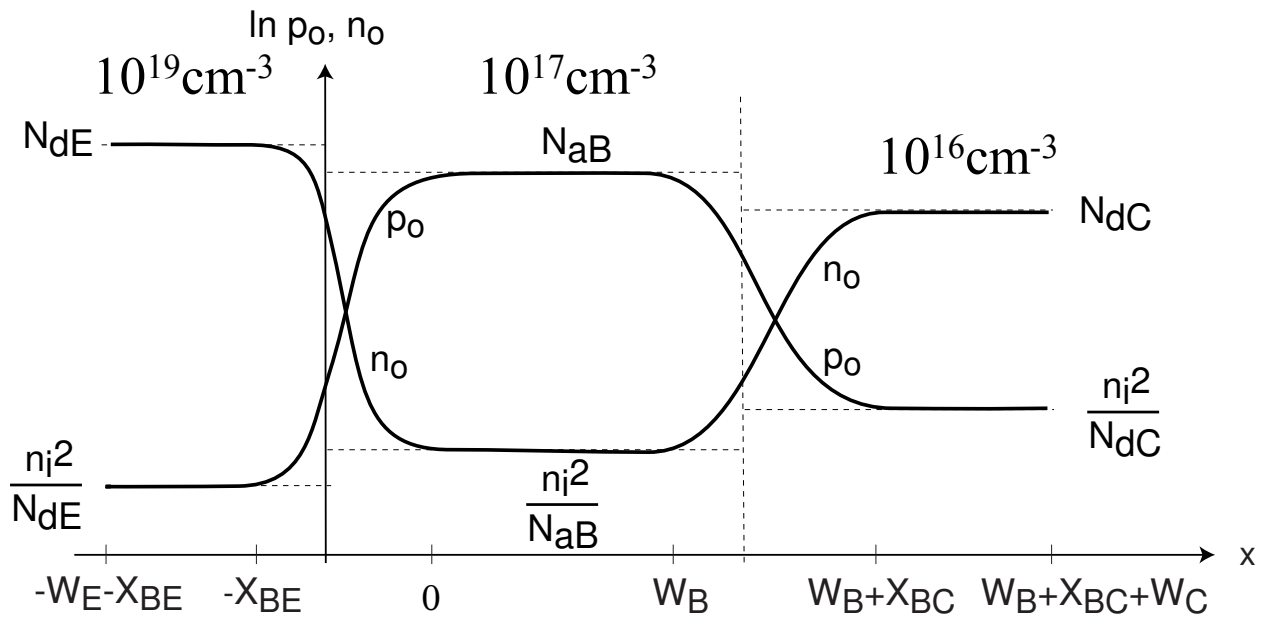


$V_{BE} > 0 \Rightarrow$ injection of electrons from the *Emitter* to the *Base*
injection of holes from the *Base* to the *Emitter*

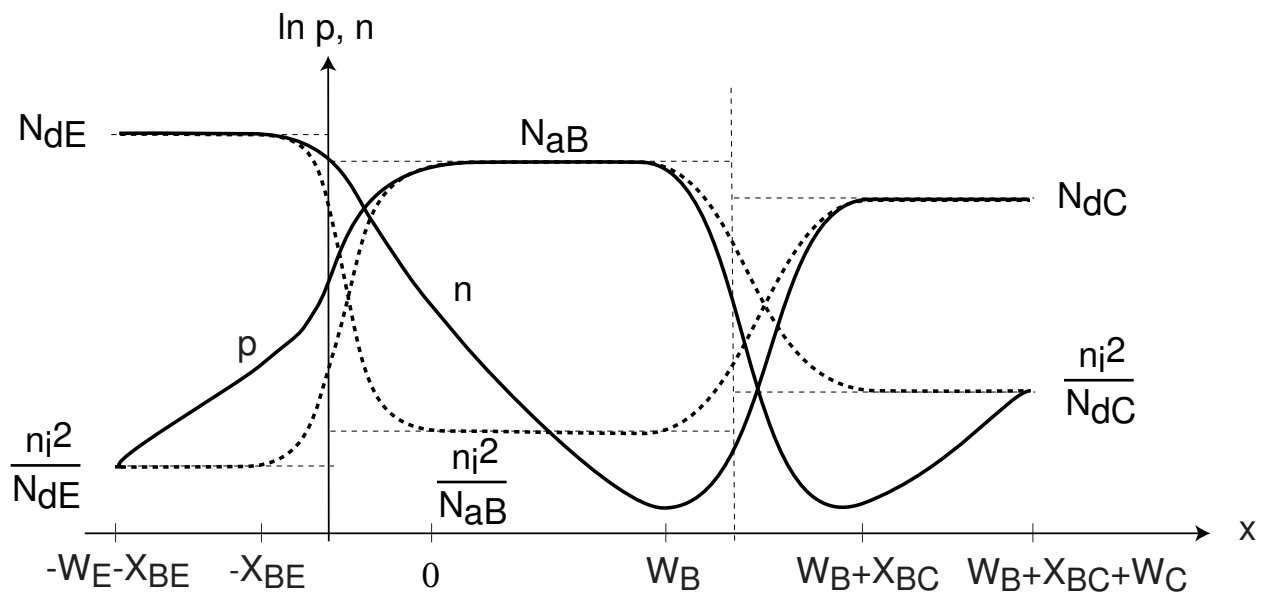
$V_{BC} < 0 \Rightarrow$ extraction of electrons from the *Base* to the *Collector*
extraction of holes from the *Collector* to the *Base*

Basic Operation: forward-active regime

- Carrier profiles in thermal equilibrium:

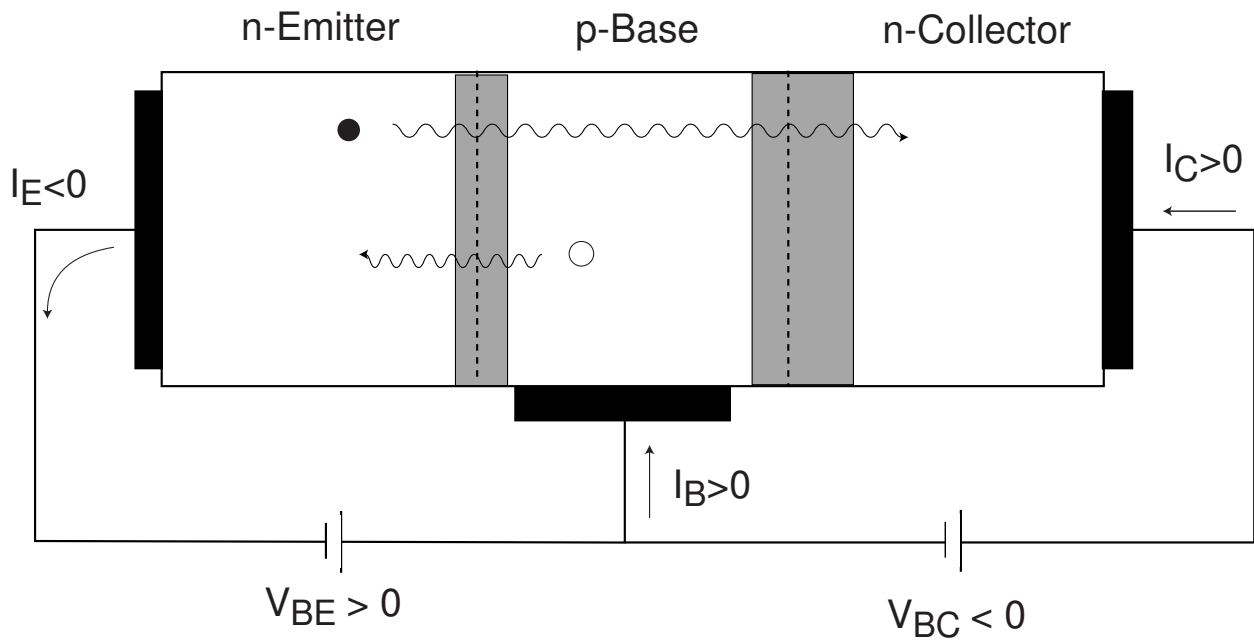


- Carrier profiles in forward-active regime:



Basic Operation: forward-active regime

Dominant current paths in forward active regime:



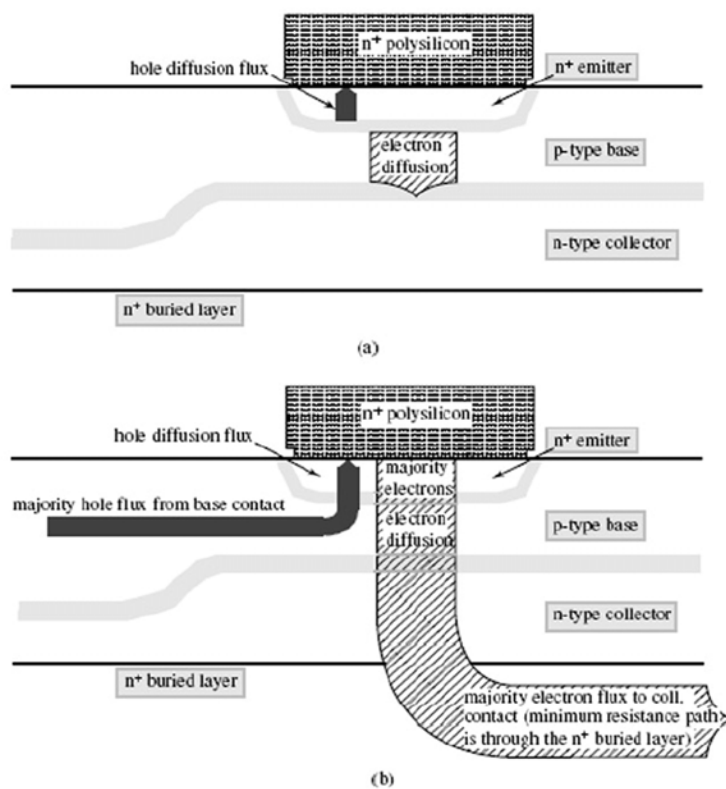
I_C : electron injection from *Emitter* to *Base* and collection by *Collector*

I_B : hole injection from *Base* to *Emitter*

I_E : $I_E = -(I_C + I_B)$

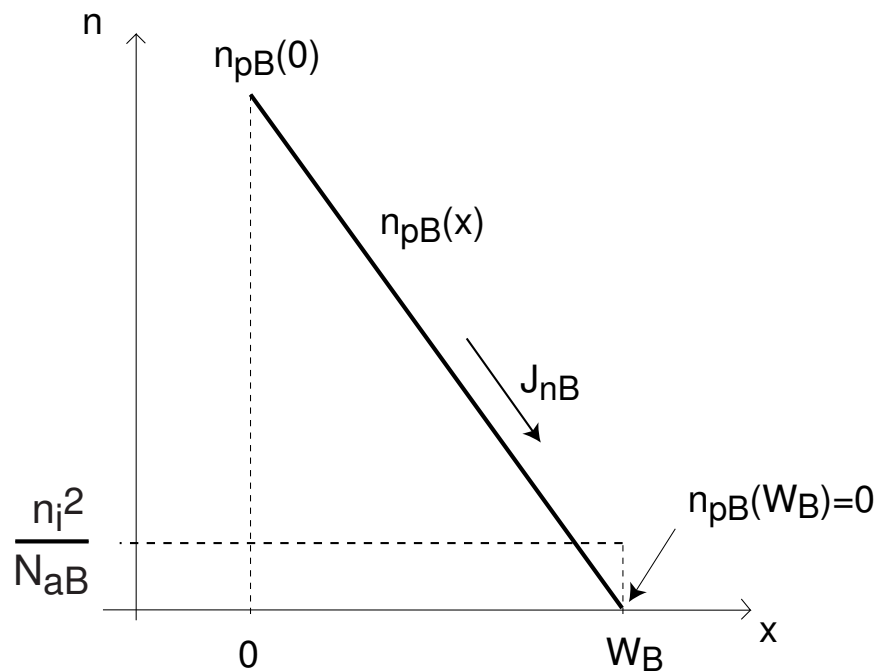
The Flux Picture - Forward Active Region

- The width of the electron flux “stream” is greater than the hole flux stream.
- The **electrons** are supplied by the emitter contact **injected** across the base-emitter SCR and **diffuse** across the base
- Electric field in the base-collector SCR **extracts** electrons into the collector.
- Holes are supplied by the base contact and diffuse across the emitter.
- The reverse injected holes recombine at the emitter ohmic contact.



2. I-V characteristics in forward-active regime

Collector current: focus on electron diffusion in base



Boundary conditions:

$$n_{pB}(0) = n_{pB0} e^{\left[\frac{V_{BE}}{V_{th}} \right]}, \quad n_{pB}(W_B) = 0$$

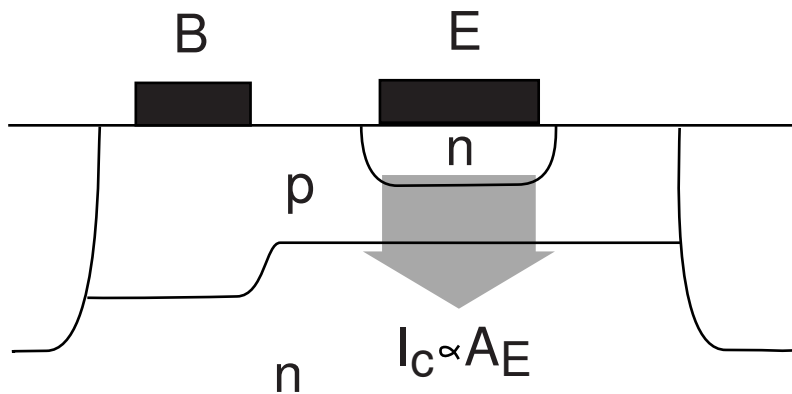
Electron profile:

$$n_{pB}(x) = n_{pB}(0) \left[1 - \frac{x}{W_B} \right]$$

Electron current density:

$$J_{nB} = qD_n \frac{dn_{pB}}{dx} = -qD_n \frac{n_{pB}(0)}{W_B}$$

Collector current scales with area of base-emitter junction A_E :



Collector terminal current:

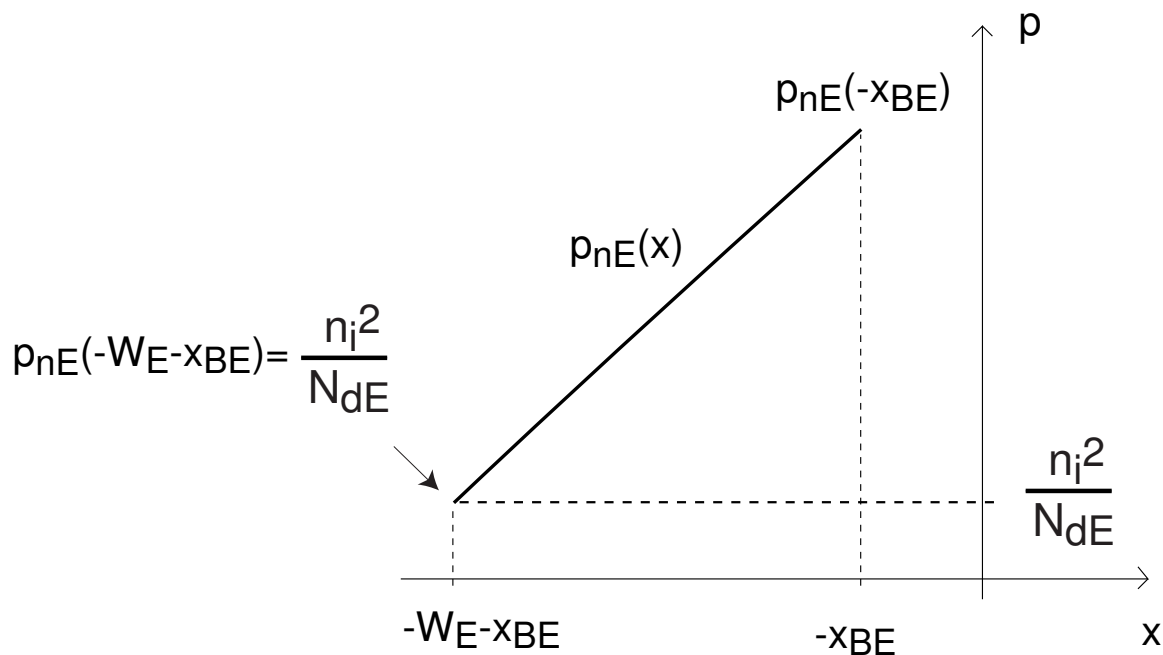
$$I_C = -J_{nB} A_E = q A_E \frac{D_n}{W_B} n_{pB0} \cdot e^{\left[\frac{V_{BE}}{V_{th}} \right]}$$

or

$$I_C = I_S e^{\left[\frac{V_{BE}}{V_{th}} \right]}$$

$I_S \equiv$ transistor saturation current

Base current: focus on hole injection and recombination at emitter contact.



Boundary conditions:

$$p_{nE}(-x_{BE}) = p_{nE0} e^{\left[\frac{V_{BE}}{V_{th}} \right]}, \quad p_{nE}(-W_E - x_{BE}) = p_{nE0}$$

Hole profile:

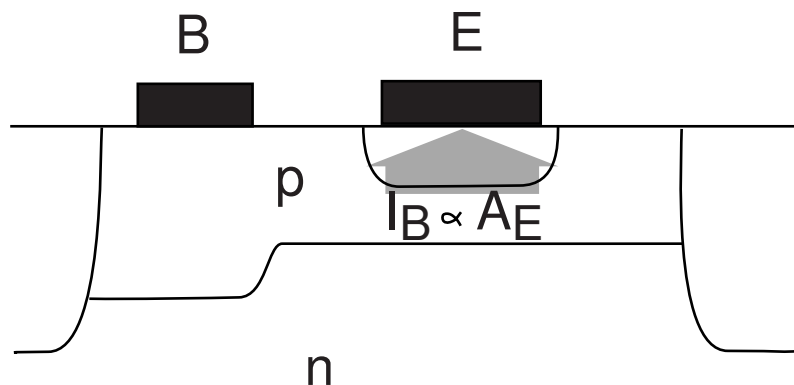
$$p_{nE}(x) = \left[p_{nE}(-x_{BE}) - p_{nE0} \right] \cdot \left(1 + \frac{x + x_{BE}}{W_E} \right) + p_{nE0}$$

Hole current density:

$$J_{pE} = -qD_p \frac{dp_{nE}}{dx} = -qD_p \frac{p_{nE}(-x_{BE}) - p_{nEo}}{W_E}$$

Base current scales with area of base-emitter junction

A_E :



Base terminal current:

$$I_B = -J_{pE} A_E = qA_E \frac{D_p}{W_E} p_{nEo} \cdot \left(e^{\left[\frac{V_{BE}}{V_{th}} \right]} - 1 \right)$$

$$I_B \approx qA_E \frac{D_p}{W_E} p_{nEo} \cdot e^{\left[\frac{V_{BE}}{V_{th}} \right]}$$

Emitter current: $-(I_B + I_C)$

$$I_E = - \left[\left(qA_E \frac{D_p}{W_E} p_{nEo} \right) + \left(qA_E \frac{D_n}{W_B} n_{pBo} \right) \right] \cdot e^{\left[\frac{V_{BE}}{V_{th}} \right]}$$

Forward Active Region: Current gain

$$\alpha_F = \frac{I_C}{|I_E|} = \frac{1}{1 + \frac{N_{aB} D_p W_B}{N_{dE} D_n W_E}}$$

Want α_F close to unity---> typically $\alpha_F = 0.99$

$$I_B = -I_E - I_C = \frac{I_C}{\alpha_F} - I_C = I_C \left(\frac{1 - \alpha_F}{\alpha_F} \right)$$

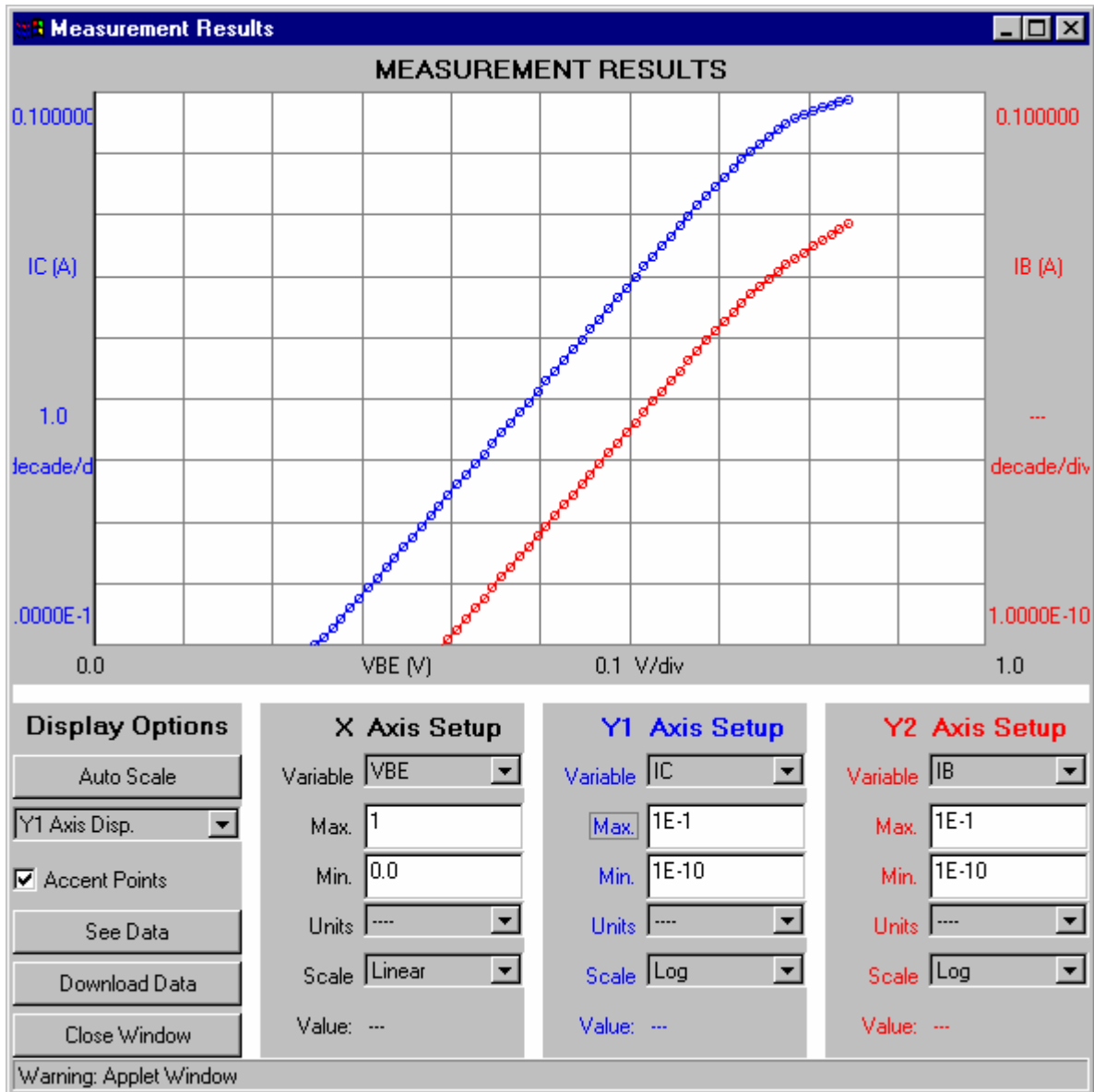
$$\beta_F = \frac{I_C}{I_B} = \left(\frac{\alpha_F}{1 - \alpha_F} \right)$$

$$\beta_F = \frac{I_C}{I_B} = \frac{n_{pB0} \cdot \frac{D_n}{W_B}}{p_{nE0} \cdot \frac{D_p}{W_E}} = \frac{N_{dE} D_n W_E}{N_{aB} D_p W_B}$$

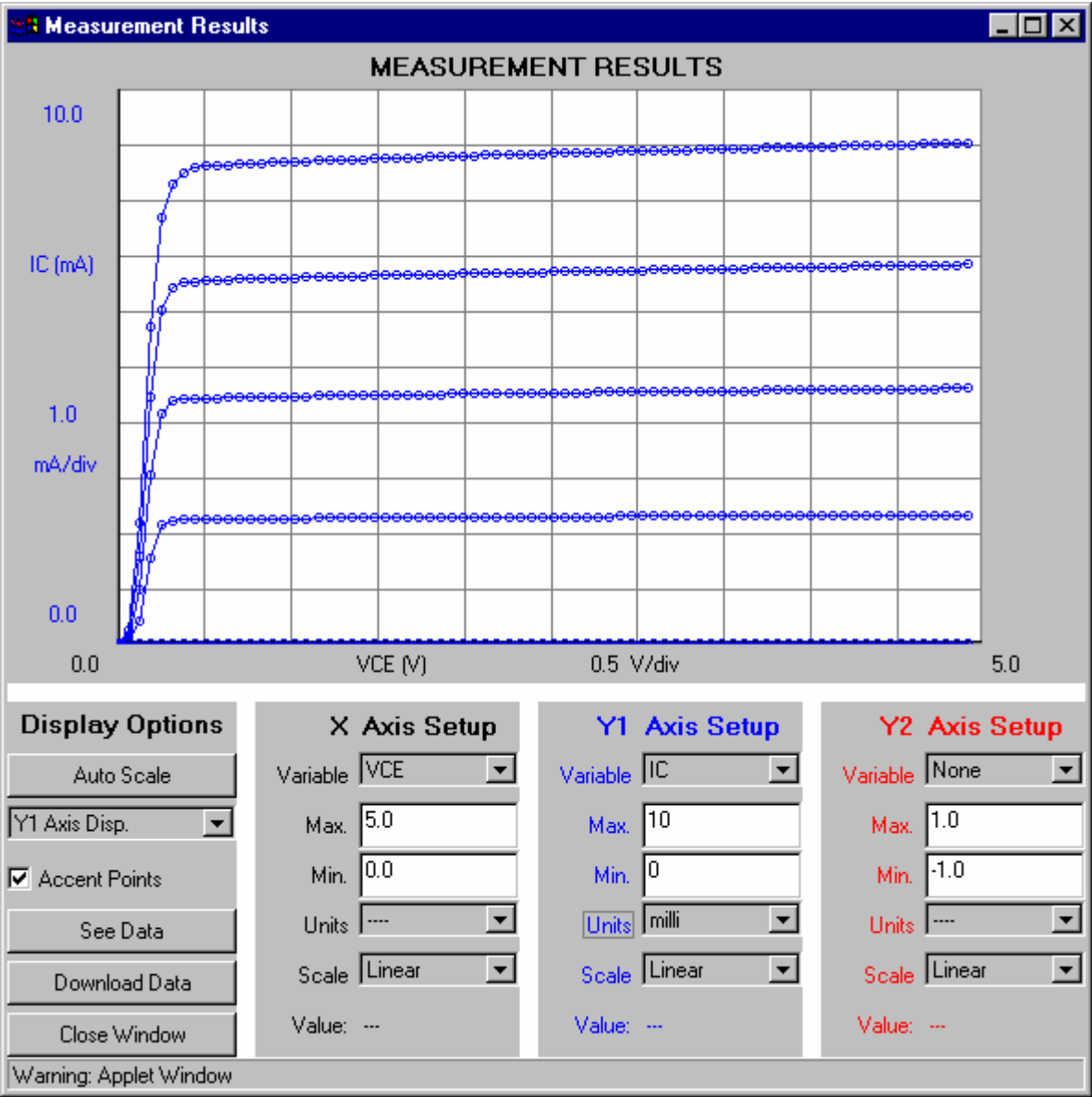
To maximize β_F :

- $N_{dE} \gg N_{aB}$
- $W_E \gg W_B$
- want npn, rather than pnp design because $D_n > D_p$

Plot of $\log I_C$ and $\log I_B$ vs V_{BE}



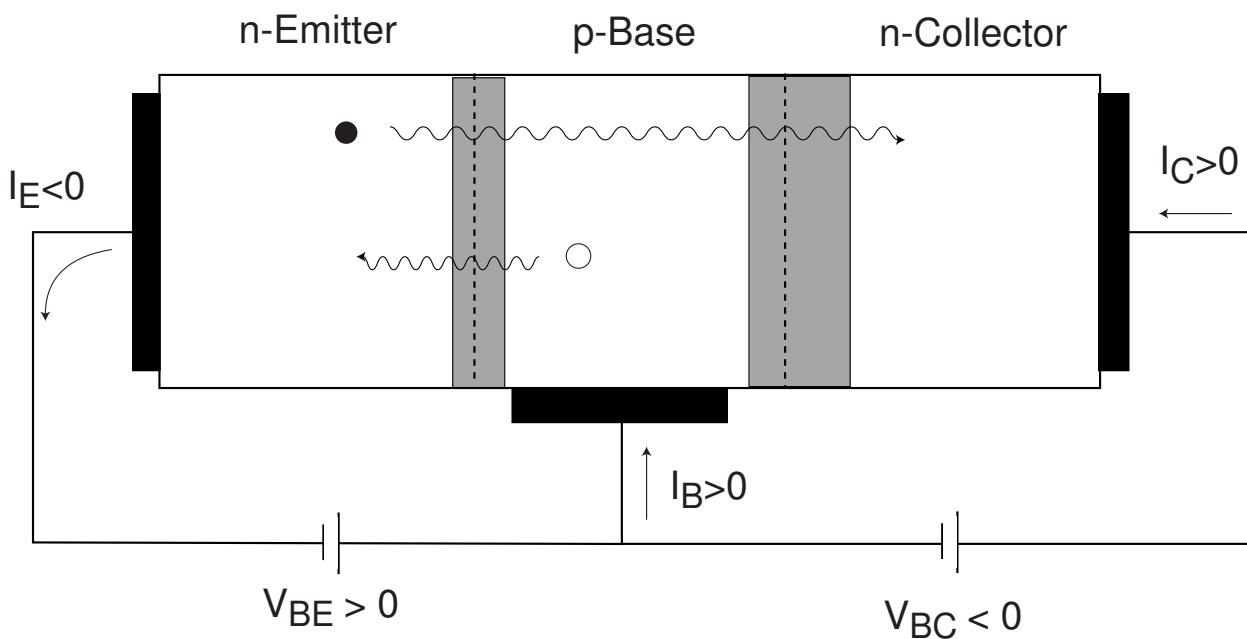
Common-Emitter Output Characteristics



What did we learn today?

Summary of Key Concepts

npn BJT in forward active regime:



- **Emitter** “injects” electrons into **Base**, **Collector** “collects” electrons from **Base**
 - I_C controlled by V_{BE} , independent of V_{BC}
 - (*transistor effect*)

$$I_C \propto e^{\left[\frac{V_{BE}}{V_{th}} \right]}$$

- **Base**: injects holes into **Emitter** $\Rightarrow I_B$

$$I_C \propto I_B$$

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